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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

| Details | |
|---------------------------------|--|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 15 ns |
| Voltage Supply - Internal | 4.75V ~ 5.25V |
| Number of Logic Elements/Blocks | 12 |
| Number of Macrocells | 192 |
| Number of Gates | 3750 |
| Number of I/O | 124 |
| Operating Temperature | 0°C ~ 70°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 160-BQFP |
| Supplier Device Package | 160-PQFP (28x28) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/epm7192sqc160-15n |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

| Table 2. MAX | 7000S Device I | Features - | | | | |
|------------------------|----------------|------------|----------|----------|----------|----------|
| Feature | EPM7032S | EPM7064S | EPM7128S | EPM7160S | EPM7192S | EPM7256S |
| Usable gates | 600 | 1,250 | 2,500 | 3,200 | 3,750 | 5,000 |
| Macrocells | 32 | 64 | 128 | 160 | 192 | 256 |
| Logic array blocks | 2 | 4 | 8 | 10 | 12 | 16 |
| Maximum user I/O pins | 36 | 68 | 100 | 104 | 124 | 164 |
| t _{PD} (ns) | 5 | 5 | 6 | 6 | 7.5 | 7.5 |
| t _{SU} (ns) | 2.9 | 2.9 | 3.4 | 3.4 | 4.1 | 3.9 |
| t _{FSU} (ns) | 2.5 | 2.5 | 2.5 | 2.5 | 3 | 3 |
| t _{CO1} (ns) | 3.2 | 3.2 | 4 | 3.9 | 4.7 | 4.7 |
| f _{CNT} (MHz) | 175.4 | 175.4 | 147.1 | 149.3 | 125.0 | 128.2 |

...and More Features

- Open-drain output option in MAX 7000S devices
- Programmable macrocell flipflops with individual clear, preset, clock, and clock enable controls
- Programmable power-saving mode for a reduction of over 50% in each macrocell
- Configurable expander product-term distribution, allowing up to 32 product terms per macrocell
- 44 to 208 pins available in plastic J-lead chip carrier (PLCC), ceramic pin-grid array (PGA), plastic quad flat pack (PQFP), power quad flat pack (RQFP), and 1.0-mm thin quad flat pack (TQFP) packages
- Programmable security bit for protection of proprietary designs
- 3.3-V or 5.0-V operation
 - MultiVoltTM I/O interface operation, allowing devices to interface with 3.3-V or 5.0-V devices (MultiVolt I/O operation is not available in 44-pin packages)
 - Pin compatible with low-voltage MAX 7000A and MAX 7000B devices
- Enhanced features available in MAX 7000E and MAX 7000S devices
 - Six pin- or logic-driven output enable signals
 - Two global clock signals with optional inversion
 - Enhanced interconnect resources for improved routability
 - Fast input setup times provided by a dedicated path from I/O pin to macrocell registers
 - Programmable output slew-rate control
- Software design support and automatic place-and-route provided by Altera's development system for Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations

Each programmable register can be clocked in three different modes:

- By a global clock signal. This mode achieves the fastest clock-tooutput performance.
- By a global clock signal and enabled by an active-high clock enable. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- By an array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

In EPM7032, EPM7064, and EPM7096 devices, the global clock signal is available from a dedicated clock pin, GCLK1, as shown in Figure 1. In MAX 7000E and MAX 7000S devices, two global clock signals are available. As shown in Figure 2, these global clock signals can be the true or the complement of either of the global clock pins, GCLK1 or GCLK2.

Each register also supports asynchronous preset and clear functions. As shown in Figures 3 and 4, the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear of the register are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the active-low dedicated global clear pin (GCLRn). Upon power-up, each register in the device will be set to a low state.

All MAX 7000E and MAX 7000S I/O pins have a fast input path to a macrocell register. This dedicated path allows a signal to bypass the PIA and combinatorial logic and be driven to an input D flipflop with an extremely fast (2.5 ns) input setup time.

Expander Product Terms

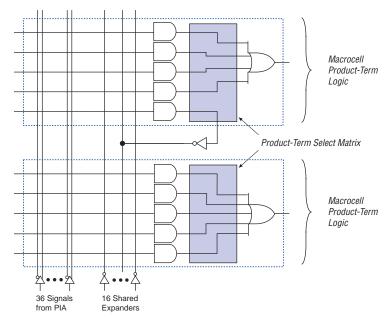
Although most logic functions can be implemented with the five product terms available in each macrocell, the more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources; however, the MAX 7000 architecture also allows both shareable and parallel expander product terms ("expanders") that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay (t_{SEXP}) is incurred when shareable expanders are used. Figure 5 shows how shareable expanders can feed multiple macrocells.

Figure 5. Shareable Expanders

Shareable expanders can be shared by any or all macrocells in an LAB.



Parallel Expanders

Parallel expanders are unused product terms that can be allocated to a neighboring macrocell to implement fast, complex logic functions. Parallel expanders allow up to 20 product terms to directly feed the macrocell OR logic, with five product terms provided by the macrocell and 15 parallel expanders provided by neighboring macrocells in the LAB.

Programming Times

The time required to implement each of the six programming stages can be broken into the following two elements:

- A pulse time to erase, program, or read the EEPROM cells.
- A shifting time based on the test clock (TCK) frequency and the number of TCK cycles to shift instructions, address, and data into the device.

By combining the pulse and shift times for each of the programming stages, the program or verify time can be derived as a function of the TCK frequency, the number of devices, and specific target device(s). Because different ISP-capable devices have a different number of EEPROM cells, both the total fixed and total variable times are unique for a single device.

Programming a Single MAX 7000S Device

The time required to program a single MAX 7000S device in-system can be calculated from the following formula:

$$t_{PROG} = t_{PPULSE} + \frac{Cycle_{PTCK}}{f_{TCK}}$$

where: t_{PROG} = Programming time t_{PPULSE} = Sum of the fixed times to erase, program, and

verify the EEPROM cells

 $Cycle_{PTCK}$ = Number of TCK cycles to program a device

= TCK frequency

The ISP times for a stand-alone verification of a single MAX 7000S device can be calculated from the following formula:

$$t_{VER} = t_{VPULSE} + \frac{Cycle_{VTCK}}{f_{TCK}}$$

where: t_{VER} = Verify time

 t_{VPULSE} = Sum of the fixed times to verify the EEPROM cells

 $Cycle_{VTCK}$ = Number of TCK cycles to verify a device

Programmable Speed/Power Control

MAX 7000 devices offer a power-saving mode that supports low-power operation across user-defined signal paths or the entire device. This feature allows total power dissipation to be reduced by 50% or more, because most logic applications require only a small fraction of all gates to operate at maximum frequency.

The designer can program each individual macrocell in a MAX 7000 device for either high-speed (i.e., with the Turbo BitTM option turned on) or low-power (i.e., with the Turbo Bit option turned off) operation. As a result, speed-critical paths in the design can run at high speed, while the remaining paths can operate at reduced power. Macrocells that run at low power incur a nominal timing delay adder (t_{LPA}) for the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , and t_{SEXP} , t_{ACL} , and t_{CPPW} parameters.

Output Configuration

MAX 7000 device outputs can be programmed to meet a variety of system-level requirements.

MultiVolt I/O Interface

MAX 7000 devices—except 44-pin devices—support the MultiVolt I/O interface feature, which allows MAX 7000 devices to interface with systems that have differing supply voltages. The 5.0-V devices in all packages can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of VCC pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a 5.0-V $V_{\rm CCINT}$ level, input voltage thresholds are at TTL levels, and are therefore compatible with both 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or a 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V supply, the output levels are compatible with 5.0-V systems. When $V_{\rm CCIO}$ is connected to a 3.3-V supply, the output high is 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with $V_{\rm CCIO}$ levels lower than 4.75 V incur a nominally greater timing delay of $t_{\rm OD2}$ instead of $t_{\rm OD1}$.

Open-Drain Output Option (MAX 7000S Devices Only)

MAX 7000S devices provide an optional open-drain (functionally equivalent to open-collector) output for each I/O pin. This open-drain output enables the device to provide system-level control signals (e.g., interrupt and write enable signals) that can be asserted by any of several devices. It can also provide an additional wired-OR plane.

IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

MAX 7000 devices support JTAG BST circuitry as specified by IEEE Std. 1149.1-1990. Table 9 describes the JTAG instructions supported by the MAX 7000 family. The pin-out tables (see the Altera web site (http://www.altera.com) or the *Altera Digital Library* for pin-out information) show the location of the JTAG control pins for each device. If the JTAG interface is not required, the JTAG pins are available as user I/O pins.

| Table 9. MAX 7000 J | ITAG Instruction | s |
|---------------------|--|---|
| JTAG Instruction | Devices | Description |
| SAMPLE/PRELOAD | EPM7128S EPM7160S EPM7192S | Allows a snapshot of signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern output at the device pins. |
| | EPM7256S | pattern output at the device pins. |
| EXTEST | EPM7128S EPM7160S EPM7192S EPM7256S | Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins. |
| BYPASS | EPM7032S EPM7064S EPM7128S EPM7160S EPM7192S EPM7256S | Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through a selected device to adjacent devices during normal device operation. |
| IDCODE | EPM7032S EPM7064S EPM7128S EPM7160S EPM7192S EPM7256S | Selects the IDCODE register and places it between TDI and TDO, allowing the IDCODE to be serially shifted out of TDO. |
| ISP Instructions | EPM7032S EPM7064S EPM7128S EPM7160S EPM7192S EPM7256S | These instructions are used when programming MAX 7000S devices via the JTAG ports with the MasterBlaster, ByteBlasterMV, BitBlaster download cable, or using a Jam File (.jam), Jam Byte-Code file (.jbc), or Serial Vector Format file (.svf) via an embedded processor or test equipment. |

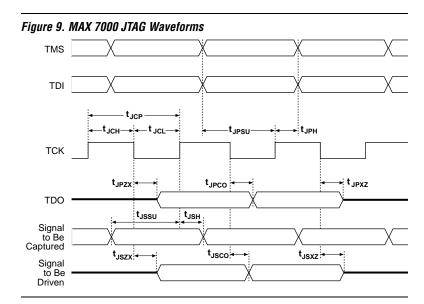


Figure 9 shows the timing requirements for the JTAG signals.

Table 12 shows the JTAG timing parameters and values for MAX 7000S devices.

| Table 1 | 2. JTAG Timing Parameters & Values for MAX 70 | 000S De | vices | |
|-------------------|--|---------|-------|------|
| Symbol | Parameter | Min | Max | Unit |
| t _{JCP} | TCK clock period | 100 | | ns |
| t _{JCH} | TCK clock high time | 50 | | ns |
| t _{JCL} | TCK clock low time | 50 | | ns |
| t _{JPSU} | JTAG port setup time | 20 | | ns |
| t _{JPH} | JTAG port hold time | 45 | | ns |
| t _{JPCO} | JTAG port clock to output | | 25 | ns |
| t _{JPZX} | JTAG port high impedance to valid output | | 25 | ns |
| t _{JPXZ} | JTAG port valid output to high impedance | | 25 | ns |
| t _{JSSU} | Capture register setup time | 20 | | ns |
| t _{JSH} | Capture register hold time | 45 | | ns |
| t _{JSCO} | Update register clock to output | | 25 | ns |
| t _{JSZX} | Update register high impedance to valid output | | 25 | ns |
| t _{JSXZ} | Update register valid output to high impedance | | 25 | ns |



For more information, see *Application Note* 39 (*IEEE 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices*).

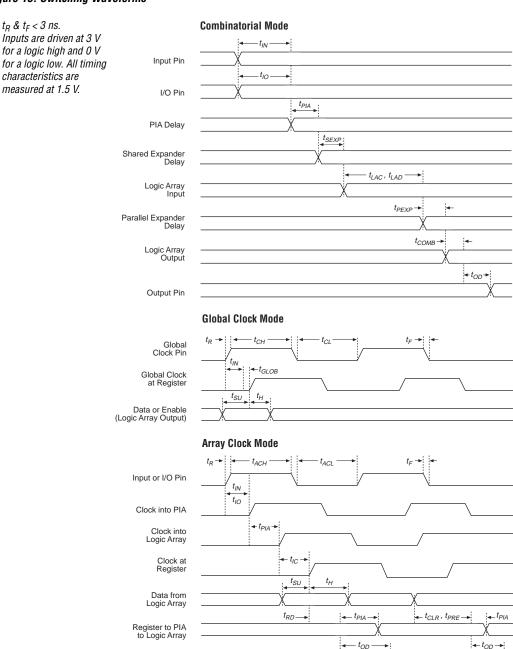
Operating Conditions

Tables 13 through 18 provide information about absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V MAX 7000 devices.

| Table 1 | 3. MAX 7000 5.0-V Device Abso | plute Maximum Ratings Note (1) | | | |
|------------------|-------------------------------|------------------------------------|------|-----|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{CC} | Supply voltage | With respect to ground (2) | -2.0 | 7.0 | V |
| VI | DC input voltage | | -2.0 | 7.0 | V |
| I _{OUT} | DC output current, per pin | | -25 | 25 | mA |
| T _{STG} | Storage temperature | No bias | -65 | 150 | ° C |
| T _{AMB} | Ambient temperature | Under bias | -65 | 135 | ° C |
| TJ | Junction temperature | Ceramic packages, under bias | | 150 | °C |
| | | PQFP and RQFP packages, under bias | | 135 | °C |

| Symbol | Parameter | Conditions | Min | Max | Unit |
|--------------------|---|--------------------|----------------|--------------------------|------|
| V _{CCINT} | Supply voltage for internal logic and input buffers | (3), (4), (5) | 4.75 (4.50) | 5.25 (5.50) | V |
| - | Supply voltage for output drivers, 5.0-V operation | (3), (4) | 4.75 (4.50) | 5.25 (5.50) | V |
| | Supply voltage for output drivers, 3.3-V operation | (3), (4), (6) | 3.00 (3.00) | 3.60 (3.60) | V |
| V _{CCISP} | Supply voltage during ISP | (7) | 4.75 | 5.25 | V |
| V _I | Input voltage | | -0.5 (8) | V _{CCINT} + 0.5 | V |
| Vo | Output voltage | | 0 | V _{CCIO} | V |
| T _A | Ambient temperature | For commercial use | 0 | 70 | °C |
| | | For industrial use | -40 | 85 | °C |
| TJ | Junction temperature | For commercial use | 0 | 90 | °C |
| | | For industrial use | -40 | 105 | ° C |
| t _R | Input rise time | | | 40 | ns |
| t _F | Input fall time | | | 40 | ns |

Figure 13. Switching Waveforms



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Register Output to Pin

| Table 2 | 21. MAX 7000 & MAX 7000E Ext | ernal Timing Param | eters Note | (1) | | | | | | |
|-------------------|--|--------------------|------------|-------------|-------|------------------------|-----|--|--|--|
| Symbol | Parameter | Conditions | | Speed Grade | | | | | | |
| | | | MAX 700 | 0E (-10P) | | 000 (-10) 00E (-10) | | | | |
| | | | Min | Max | Min | Max | | | | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 10.0 | | 10.0 | ns | | | |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 10.0 | | 10.0 | ns | | | |
| t _{SU} | Global clock setup time | | 7.0 | | 8.0 | | ns | | | |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns | | | |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns | | | |
| t _{FH} | Global clock hold time of fast input | (2) | 0.5 | | 0.5 | | ns | | | |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 5.0 | | 5 | ns | | | |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns | | | |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns | | | |
| t _{ASU} | Array clock setup time | | 2.0 | | 3.0 | | ns | | | |
| t _{AH} | Array clock hold time | | 3.0 | | 3.0 | | ns | | | |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 10.0 | | 10.0 | ns | | | |
| t _{ACH} | Array clock high time | | 4.0 | | 4.0 | | ns | | | |
| t _{ACL} | Array clock low time | | 4.0 | | 4.0 | | ns | | | |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 4.0 | | 4.0 | | ns | | | |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns | | | |
| t _{CNT} | Minimum global clock period | | | 10.0 | | 10.0 | ns | | | |
| f _{CNT} | Maximum internal global clock frequency | (5) | 100.0 | | 100.0 | | MHz | | | |
| t _{ACNT} | Minimum array clock period | | | 10.0 | | 10.0 | ns | | | |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 100.0 | | 100.0 | | MHz | | | |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz | | | |

| Symbol | Parameter | Conditions | | Speed | Grade | | Unit |
|-------------------|--|----------------|---------|-----------|--------|------|------|
| | | | MAX 700 | OE (-10P) | MAX 70 | | |
| | | | Min | Max | Min | Max | |
| t _{IN} | Input pad and buffer delay | | | 0.5 | | 1.0 | ns |
| t _{IO} | I/O input pad and buffer delay | | | 0.5 | | 1.0 | ns |
| t _{FIN} | Fast input delay | (2) | | 1.0 | | 1.0 | ns |
| t _{SEXP} | Shared expander delay | | | 5.0 | | 5.0 | ns |
| t _{PEXP} | Parallel expander delay | | | 0.8 | | 0.8 | ns |
| t_{LAD} | Logic array delay | | | 5.0 | | 5.0 | ns |
| t _{LAC} | Logic control array delay | | | 5.0 | | 5.0 | ns |
| t _{IOE} | Internal output enable delay | (2) | | 2.0 | | 2.0 | ns |
| t _{OD1} | Output buffer and pad delay Slow slew rate = off V _{CCIO} = 5.0 V | C1 = 35 pF | | 1.5 | | 2.0 | ns |
| t _{OD2} | Output buffer and pad delay Slow slew rate = off V _{CCIO} = 3.3 V | C1 = 35 pF (7) | | 2.0 | | 2.5 | ns |
| t _{OD3} | Output buffer and pad delay Slow slew rate = on V _{CCIO} = 5.0 V or 3.3 V | C1 = 35 pF (2) | | 5.5 | | 6.0 | ns |
| t _{ZX1} | Output buffer enable delay Slow slew rate = off V _{CCIO} = 5.0 V | C1 = 35 pF | | 5.0 | | 5.0 | ns |
| t _{ZX2} | Output buffer enable delay Slow slew rate = off V _{CCIO} = 3.3 V | C1 = 35 pF (7) | | 5.5 | | 5.5 | ns |
| t _{ZX3} | Output buffer enable delay Slow slew rate = on V _{CCIO} = 5.0 V or 3.3 V | C1 = 35 pF (2) | | 9.0 | | 9.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 5.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 2.0 | | 3.0 | | ns |
| t_H | Register hold time | | 3.0 | | 3.0 | | ns |
| t _{FSU} | Register setup time of fast input | (2) | 3.0 | | 3.0 | | ns |
| t_{FH} | Register hold time of fast input | (2) | 0.5 | | 0.5 | | ns |
| t _{RD} | Register delay | | | 2.0 | | 1.0 | ns |
| t _{COMB} | Combinatorial delay | | | 2.0 | | 1.0 | ns |
| t _{IC} | Array clock delay | | | 5.0 | | 5.0 | ns |
| t_{EN} | Register enable time | | | 5.0 | | 5.0 | ns |
| t _{GLOB} | Global control delay | | | 1.0 | | 1.0 | ns |
| t _{PRE} | Register preset time | | | 3.0 | | 3.0 | ns |
| t _{CLR} | Register clear time | | | 3.0 | | 3.0 | ns |
| t _{PIA} | PIA delay | | | 1.0 | | 1.0 | ns |
| t _{LPA} | Low-power adder | (8) | | 11.0 | | 11.0 | ns |

| Table 2 | 23. MAX 7000 & MAX 7000E Ext | ernal Timing Param | eters Note | e (1) | | | | | |
|-------------------|--|--------------------|-------------------|-----------|-------|-----------------------|-----|--|--|
| Symbol | Parameter | Conditions | Speed Grade | | | | | | |
| | | | MAX 700 | 0E (-12P) | | 00 (-12) DOE (-12) | | | |
| | | | Min | Max | Min | Max | | | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns | | |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns | | |
| t _{SU} | Global clock setup time | | 7.0 | | 10.0 | | ns | | |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns | | |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns | | |
| t _{FH} | Global clock hold time of fast input | (2) | 0.0 | | 0.0 | | ns | | |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 6.0 | | 6.0 | ns | | |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns | | |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns | | |
| t _{ASU} | Array clock setup time | | 3.0 | | 4.0 | | ns | | |
| t _{AH} | Array clock hold time | | 4.0 | | 4.0 | | ns | | |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 12.0 | | 12.0 | ns | | |
| t _{ACH} | Array clock high time | | 5.0 | | 5.0 | | ns | | |
| t _{ACL} | Array clock low time | | 5.0 | | 5.0 | | ns | | |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 5.0 | | 5.0 | | ns | | |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns | | |
| t _{CNT} | Minimum global clock period | | | 11.0 | | 11.0 | ns | | |
| f _{CNT} | Maximum internal global clock frequency | (5) | 90.9 | | 90.9 | | MHz | | |
| t _{ACNT} | Minimum array clock period | | | 11.0 | | 11.0 | ns | | |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 90.9 | | 90.9 | | MHz | | |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz | | |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This parameter applies to MAX 7000E devices only.
- This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (4) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (5) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (6) The f_{MAX} values represent the highest frequency for pipelined data.
- (7) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in the low-power mode.

Tables 27 and 28 show the EPM7032S AC operating conditions.

| Table 2 | 77. EPM7032\$ External Time | ing Parameter | s (Part | 1 of 2 |) No | ote (1) | | | | | |
|-------------------|--|----------------|-------------|--------|-------------|---------|-------|-----|-------|------|-----|
| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | |
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns |
| t _{SU} | Global clock setup time | | 2.9 | | 4.0 | | 5.0 | | 7.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 2.5 | | 2.5 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.0 | | 0.5 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 3.2 | | 3.5 | | 4.3 | | 5.0 | ns |
| t _{CH} | Global clock high time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | | 0.7 | | 0.9 | | 1.1 | | 2.0 | | ns |
| t _{AH} | Array clock hold time | | 1.8 | | 2.1 | | 2.7 | | 3.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 5.4 | | 6.6 | | 8.2 | | 10.0 | ns |
| t _{ACH} | Array clock high time | | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 2.5 | | 2.5 | | 3.0 | | 4.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 5.7 | | 7.0 | | 8.6 | | 10.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (4) | 175.4 | | 142.9 | | 116.3 | | 100.0 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 5.7 | | 7.0 | | 8.6 | | 10.0 | ns |

| Table 27. EPM7032S External Timing Parameters (Part 2 of 2) Note (1) | | | | | | | | | | | |
|--|--|------------|-------|-----|-------|-------|-------|-----|-------|-----|------|
| Symbol | Parameter | Conditions | | | | Speed | Grade | ! | | | Unit |
| | | | - | 5 | - | -6 -7 | | 7 | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 175.4 | | 142.9 | | 116.3 | | 100.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 250.0 | | 200.0 | | 166.7 | | 125.0 | | MHz |

| Table 2 | 8. EPM7032S Internal Tim | ing Parameter | s / | Note (1) | | | | | | | |
|-------------------|-----------------------------------|----------------|------------|----------|-----|-------|-------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | | | | Speed | Grade |) | | | Unit |
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | - |
| t _{IN} | Input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t _{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t _{FIN} | Fast input delay | | | 2.2 | | 2.1 | | 2.5 | | 1.0 | ns |
| t _{SEXP} | Shared expander delay | | | 3.1 | | 3.8 | | 4.6 | | 5.0 | ns |
| t _{PEXP} | Parallel expander delay | | | 0.9 | | 1.1 | | 1.4 | | 0.8 | ns |
| t _{LAD} | Logic array delay | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t _{LAC} | Logic control array delay | | | 2.5 | | 3.3 | | 4.0 | | 5.0 | ns |
| t _{IOE} | Internal output enable delay | | | 0.7 | | 0.8 | | 1.0 | | 2.0 | ns |
| t _{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.2 | | 0.3 | | 0.4 | | 1.5 | ns |
| t _{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.7 | | 0.8 | | 0.9 | | 2.0 | ns |
| t _{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.2 | | 5.3 | | 5.4 | | 5.5 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t _{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 4.5 | | 5.5 | ns |
| t _{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 9.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t _{SU} | Register setup time | | 0.8 | | 1.0 | | 1.3 | | 2.0 | | ns |
| t _H | Register hold time | | 1.7 | | 2.0 | | 2.5 | | 3.0 | | ns |
| t _{FSU} | Register setup time of fast input | | 1.9 | | 1.8 | | 1.7 | | 3.0 | | ns |
| t _{FH} | Register hold time of fast input | | 0.6 | | 0.7 | | 0.8 | | 0.5 | | ns |
| t _{RD} | Register delay | | | 1.2 | | 1.6 | | 1.9 | | 2.0 | ns |
| t _{COMB} | Combinatorial delay | | | 0.9 | | 1.1 | | 1.4 | | 2.0 | ns |
| t _{IC} | Array clock delay | | | 2.7 | | 3.4 | | 4.2 | | 5.0 | ns |
| t _{EN} | Register enable time | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t _{GLOB} | Global control delay | | | 1.6 | | 1.4 | | 1.7 | | 1.0 | ns |
| t _{PRE} | Register preset time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |
| t _{CLR} | Register clear time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |

| Table 34. EPM7160S Internal Timing Parameters (Part 2 of 2) Note (1) | | | | | | | | | | | |
|--|---------------------|------------|-------------|------|-----|------|-----|------|-----|------|------|
| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
| | | | -6 -7 | | | -10 | | -15 | | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{CLR} | Register clear time | | | 2.4 | | 3.0 | | 3.0 | | 4.0 | ns |
| t _{PIA} | PIA delay | (7) | | 1.6 | | 2.0 | | 1.0 | | 2.0 | ns |
| t _{LPA} | Low-power adder | (8) | | 11.0 | | 10.0 | | 11.0 | | 13.0 | ns |

Notes to tables:

- These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in the low-power mode.

Tables 35 and 36 show the EPM7192S AC operating conditions.

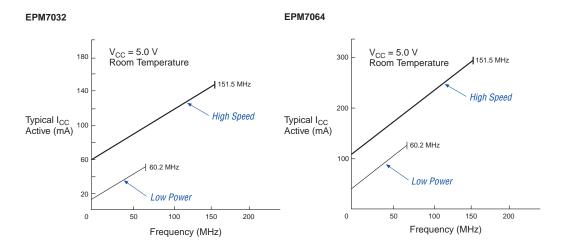
| Table 35. EPM7192S External Timing Parameters (Part 1 of 2) Note (1) | | | | | | | | | | |
|--|---------------------------------------|------------|-------------|-----|-----|------|------|------|----|--|
| Symbol | Parameter | Conditions | Speed Grade | | | | | | | |
| | | | -7 | | -10 | | -15 | | | |
| | | | Min | Max | Min | Max | Min | Max | | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 7.5 | | 10.0 | | 15.0 | ns | |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 7.5 | | 10.0 | | 15.0 | ns | |
| t _{SU} | Global clock setup time | | 4.1 | | 7.0 | | 11.0 | | ns | |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | ns | |
| t _{FSU} | Global clock setup time of fast input | | 3.0 | | 3.0 | | 3.0 | | ns | |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.5 | | 0.0 | | ns | |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 4.7 | | 5.0 | | 8.0 | ns | |
| t _{CH} | Global clock high time | | 3.0 | | 4.0 | | 5.0 | | ns | |
| t _{CL} | Global clock low time | | 3.0 | | 4.0 | | 5.0 | | ns | |
| t _{ASU} | Array clock setup time | | 1.0 | | 2.0 | | 4.0 | | ns | |

Tables 37 and 38 show the EPM7256S AC operating conditions.

| Symbol | Parameter | Conditions | Speed Grade | | | | | | |
|-------------------|---|--------------------------|-------------|-----|---------|------|---------|------|----------|
| | | | -7 -10 | | | | -15 | | Unit |
| | | | Min Max | | Min Max | | Min Max | | - |
| | | | IVIIII | 7.5 | IVIIII | 10.0 | IVIIII | 15.0 | |
| t _{PD1} | Input to non-registered output I/O input to non-registered output | C1 = 35 pF C1 = 35 pF | | 7.5 | | 10.0 | | 15.0 | ns ns |
| t _{SU} | Global clock setup time | | 3.9 | | 7.0 | | 11.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 3.0 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.5 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 4.7 | | 5.0 | | 8.0 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{ASU} | Array clock setup time | | 0.8 | | 2.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 1.9 | | 3.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 7.8 | | 10.0 | | 15.0 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 7.8 | | 10.0 | | 13.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (4) | 128.2 | | 100.0 | | 76.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 7.8 | | 10.0 | | 13.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 128.2 | | 100.0 | | 76.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 166.7 | | 125.0 | | 100.0 | | MHz |

Figure 14 shows typical supply current versus frequency for MAX 7000 devices.

Figure 14. I_{CC} vs. Frequency for MAX 7000 Devices (Part 1 of 2)



EPM7096

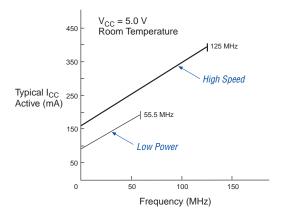
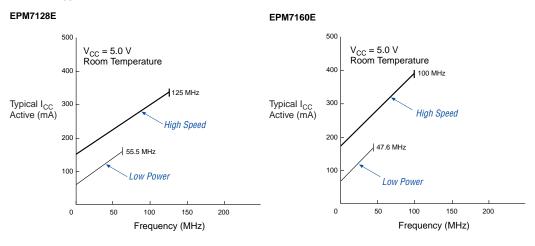


Figure 14. I_{CC} vs. Frequency for MAX 7000 Devices (Part 2 of 2)



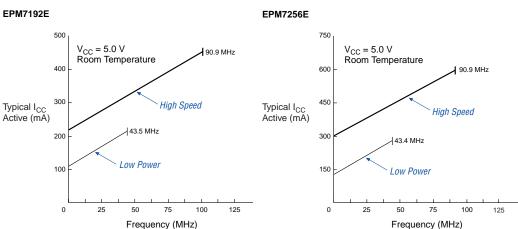
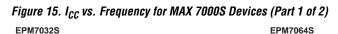
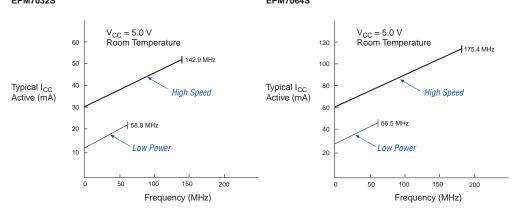


Figure 15 shows typical supply current versus frequency for MAX 7000S devices.





EPM7128S EPM7160S

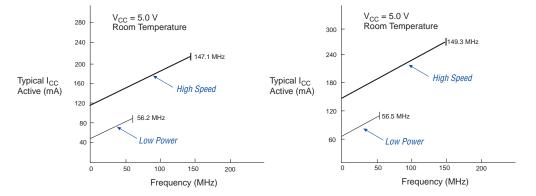


Figure 21. 192-Pin Package Pin-Out Diagram

Package outline not drawn to scale.

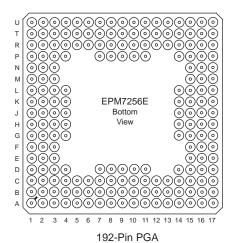


Figure 22. 208-Pin Package Pin-Out Diagram

Package outline not drawn to scale.

